

Automotive MOSFET

OptiMOS™-5 Power-Transistor







Features

- OptiMOS[™] power MOSFET for automotive applications
- N-channel Enhancement mode Logic Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested

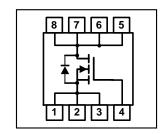


General automotive applications.

Product validation

Qualified for automotive applications. Product validation according to AEC-Q101.





Product Summary

V_{DS}	60	V
R _{DS(on)}	2.20	mΩ
I _D (chip limited)	170	Α

Туре	Package	Marking
IAUC120N06S5L022	PG-TDSON-8-34	5N06L022

IAUC120N06S5L022



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Maximum ratings

at Tj=25 °C, unless otherwise specified

dt 1j-25 °C, uniess otherwise specified							
Parameter	Symbol	Conditions	Value	Unit			
Continuous drain current	I _D	V _{GS} =10 V, Chip limitation ^{1,2)}	170	А			
		V _{GS} =10V, DC current ³⁾	120				
		T_a =85 °C, V_{GS} =10 V, R_{thJA} on 2s2p ^{2,4)}	30				
Pulsed drain current ²⁾	/ _{D,pulse}	T _C =25 °C, t _p = 100 μs	571				
Avalanche energy, single pulse ²⁾	E _{AS}	/ _D =60 A	174	mJ			
Avalanche current, single pulse	I _{AS}	-	120	А			
Gate source voltage	V _{GS}	-	±20	V			
Power dissipation	P tot	T _C =25 °C	136	W			
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 +175	°C			
IEC climatic category; DIN IEC 68-1	-	-	55/175/56				

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Thermal characteristics²⁾

Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	_	1.10	K/W
Thermal resistance, junction - ambient ⁴⁾	R _{thJA}	-	-	23.7	_	

Electrical characteristics

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Symbol Conditions	Values			Unit
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V_{GS} =0 V, I_D =1 mA	60	-	-	v
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 65 \mu A$	1.2	1.7	2.2	
Zero gate voltage drain current	I _{DSS}	V_{DS} =60 V, V_{GS} =0 V, T_{j} =25 °C	_	_	1	μΑ
		V_{DS} =60 V, V_{GS} =0 V, T_{j} =100 °C ²⁾	-	-	100	
Gate-source leakage current	I _{GSS}	V _{GS} =20 V, V _{DS} =0 V	-	-	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =60 A	-	2.61	3.12	mΩ
		V _{GS} =10 V, I _D =60 A	_	1.84	2.20]
Gate resistance ²⁾	R _G	-	_	1.4	_	Ω

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Parameter	Symbol	Symbol Conditions		Values		
			min.	typ.	max.	
Dynamic characteristics ²⁾						
Input capacitance	C iss		-	4347	5651	pF
Output capacitance	C oss	V_{GS} =0 V, V_{DS} =30 V, f =1 MHz	-	803	1044	
Reverse transfer capacitance	C _{rss}		-	38	57	
Turn-on delay time	t _{d(on)}		-	7	-	ns
Rise time	t _r	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A,	-	5	-	
Turn-off delay time	t d(off)	$R_{\rm G}$ =3.5 Ω	-	29	_	
Fall time	t f		_	16	_	
Gate to source charge Gate to drain charge	Q gs Q gd	$V_{\rm DD} = 30 \text{ V}, I_{\rm D} = 60 \text{ A},$	<u>-</u>	12 9	16 14	nC
			_	12	16	nC
Gate charge total	Q _g	$V_{\rm GS}$ =0 to 10 V	_	59	77	
Gate plateau voltage	1/					
	$V_{\rm plateau}$		_	3.0	-	V
Reverse Diode	ν plateau		-	3.0	-	V
Reverse Diode Diode continous forward current ²⁾	V plateau	т _с =25 °С	-	3.0	120	v A
	·	T_{C} =25 °C T_{C} =25 °C, t_{p} = 100 μs		3.0	<u> </u>	I
Diode continous forward current ²⁾	/ _S		-	-	120	I
Diode continous forward current ²⁾ Diode pulse current ²⁾	I _S	T _C =25 °C, t _p = 100 μs	-	-	120 562	A

¹⁾ Practically the current is limited by the overall system design including the customer-specific PCB.

 $^{^{2)}\,\}mbox{The parameter}$ is not subject to production testing – specified by design.

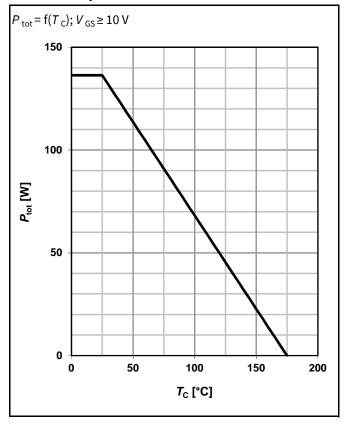
³⁾ Current is limited by package.

⁴⁾ Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

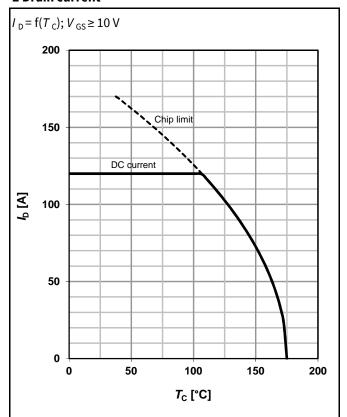


Electrical characteristics diagrams

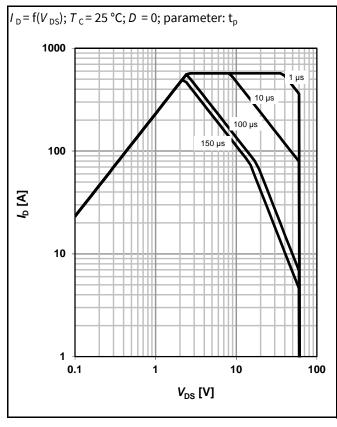
1 Power dissipation



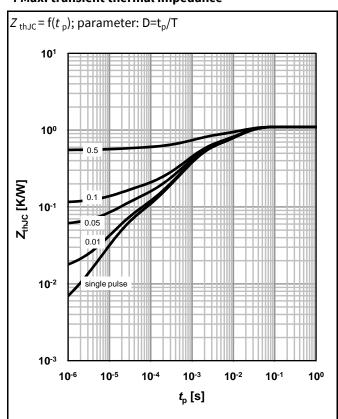
2 Drain current



3 Safe operating area

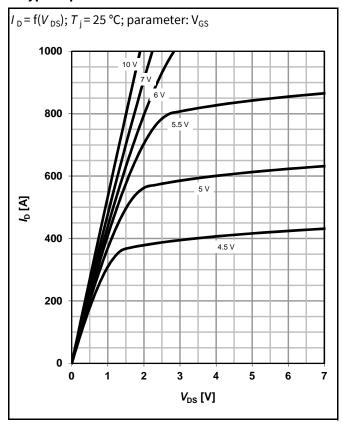


4 Max. transient thermal impedance

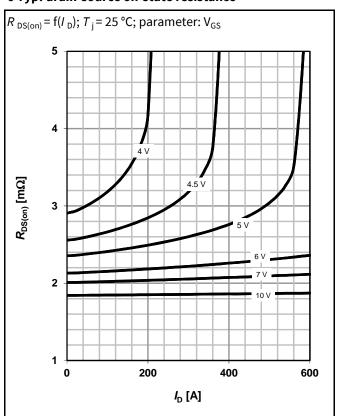




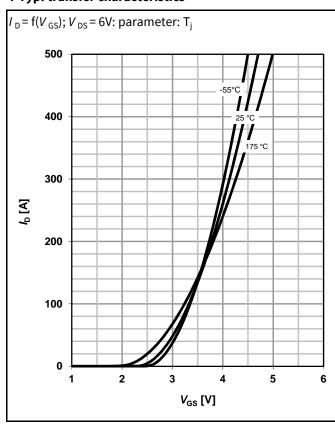
5 Typ. output characteristics



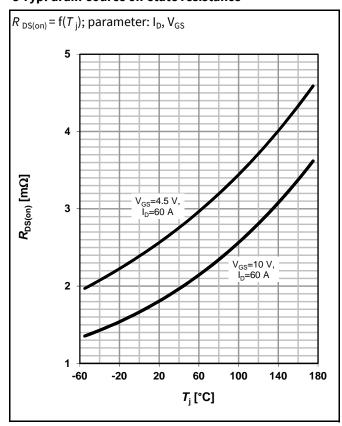
6 Typ. drain-source on-state resistance



7 Typ. transfer characteristics

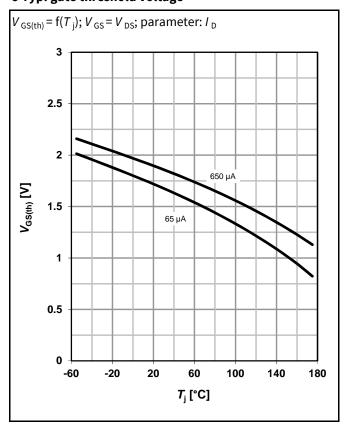


8 Typ. drain-source on-state resistance

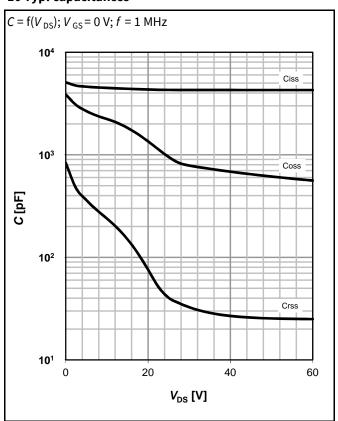


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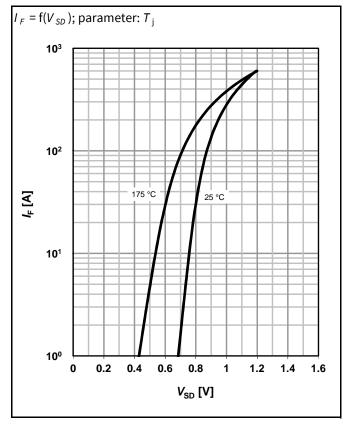
9 Typ. gate threshold voltage



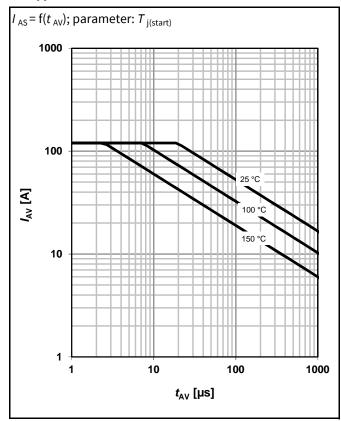
10 Typ. capacitances



11 Typical forward diode characteristics

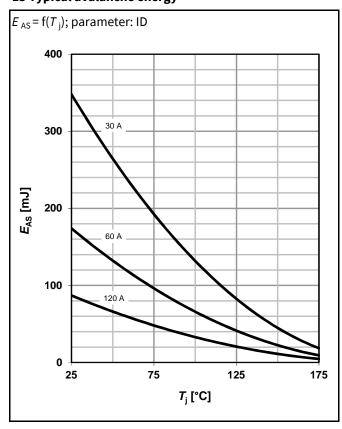


12 Typ. avalanche characteristics

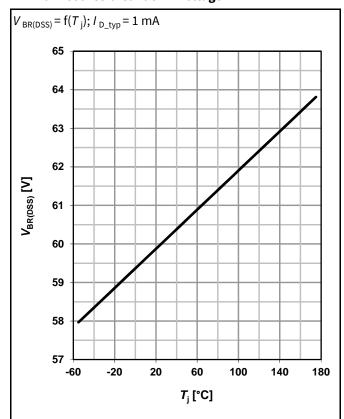


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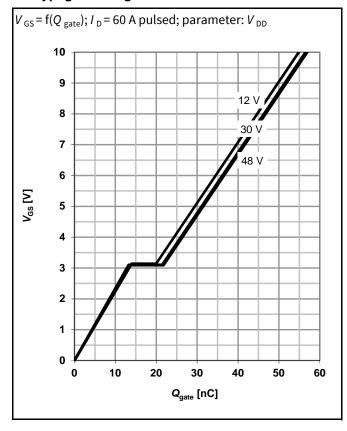
13 Typical avalanche energy



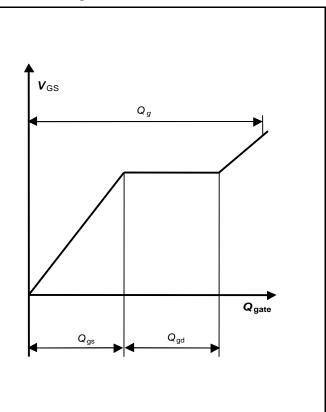
14 Drain-source breakdown voltage



15 Typ. gate charge



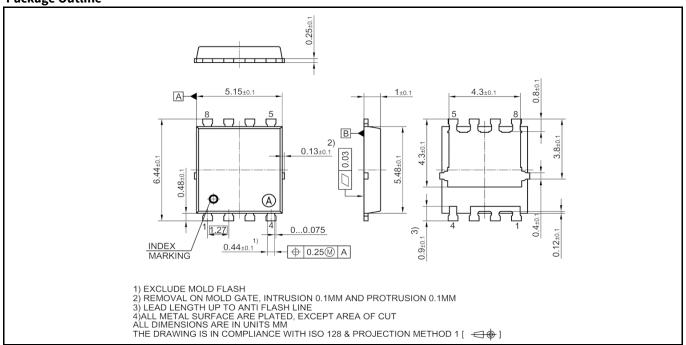
16 Gate charge waveforms



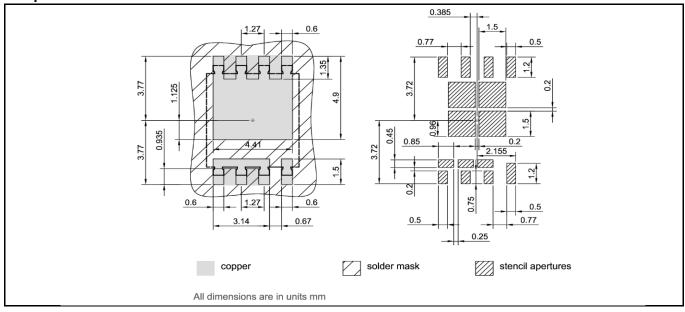
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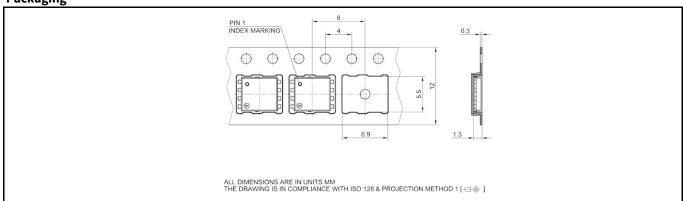
Package Outline



Footprint



Packaging



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Revision History

Revision	Date	Changes
Revision 1.0	12.07.2022	Final Data Sheet

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